

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Features

- Multiple applications: parallel, series, dual-inductor and transformer
- Magnetically shielded, low radiation
- Inductance range: 0.47 to 4000 µH
- Rated current up to 17.6 A
- RoHS compliant*

Applications

- SEPIC topology
- Power supplies for:
 - Communication equipment
 - Notebooks, desktop computers,
 - LCDs, flat panels, backlights
 - Camcorders, HDTVs, car audio systems

SRF1260 Series - Dual-Winding Shielded Power Inductors

Electrical Specifications @ 25 °C

	Parallel Rating					Series Rating				
	Inductance		DCR			Inductance		DCR		
Bourns Part No.	@ 100 KHz L (μH)	Tol. (%)	(Ω) Max.	Irms (A)	Isat (A)	@ 100 KHz L (μH)	Tol. (%)	(Ω) Max.	Irms (A)	Isat (A)
SRF1260-R47Y	0.47	±30	0.0053	17.6	33	1.88	±30	0.0212	8.8	16.5
SRF1260-1R0Y	1.0	±30	0.0053	15	23.6	4	±30	0.0212	7.51	11.8
SRF1260-1R5Y	1.5	±30	0.0002	13.8	18.3	6	±30	0.0302	6.89	9.15
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SRF1260-2R2Y	2.2	±30	0.0085	10.9		8.8	±30	0.0333	5.46	7.5
SRF1260-3R3Y	3.3	±30	0.0101	9.26	12.7	13.2	±30	0.0372	4.63	6.35
SRF1260-4R7Y	4.7	±30	0.0137	7.18	9.71	18.8	±30	0.0479	3.59	4.86
SRF1260-6R8Y	6.8	±30	0.0186	6.64	8.68	27.2	±30	0.0672	3.32	4.34
SRF1260-8R2Y	8.2	±30	0.0194	5.54	7.86	32.8	±30	0.0737	2.77	3.93
SRF1260-100M	10	±20	0.0246	5.35	7.17	40	±20	0.0934	2.67	3.59
SRF1260-150M	15	±20	0.0329	4.27	5.69	60	±20	0.125	2.13	2.85
SRF1260-220M	22	±20	0.0451	3.7	4.71	88	±20	0.172	1.84	2.36
SRF1260-330M	33	±20	0.0618	3.28	3.84	132	±20	0.256	1.64	1.92
SRF1260-470M	47	±20	0.086	2.71	3.24	188	±20	0.34	1.35	1.62
SRF1260-680M	68	±20	0.117	2.22	2.7	272	±20	0.444	1.11	1.35
SRF1260-820M	82	±20	0.15	2.05	2.39	328	±20	0.568	1.03	1.2
SRF1260-101M	100	±20	0.171	1.78	2.2	400	±20	0.656	0.892	1.1
SRF1260-151M	150	±20	0.254	1.48	1.81	600	±20	0.972	0.739	0.905
SRF1260-221M	220	±20	0.354	1.19	1.51	880	±20	1.416	0.594	0.755
SRF1260-331M	330	±20	0.574	1.06	1.22	1320	±20	2.29	0.53	0.61
SRF1260-471M	470	±20	0.83	0.87	1.02	1880	±20	3.197	0.434	0.51
SRF1260-681M	680	±20	1.212	0.7	0.85	2720	±20	4.635	0.35	0.425
SRF1260-821M	820	±20	1.46	0.6	0.77	3280	±20	5.363	0.301	0.385
SRF1260-102M	1000	±20	1.854	0.57	0.7	4000	±20	6.782	0.283	0.35

General Specifications

Test Voltage0.25 V Hi-pot......500 Vrms, 3 mA, 3 sec. Reflow Soldering .. 230 °C; 50 sec. max. Operating Temperature

.....-40 °C to +125 °C (Temperature rise included)

Storage Temperature .. -40 °C to +125 °C Resistance to Solder Heat

.....+260 °C for 10 sec.

Materials

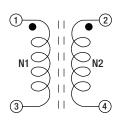
Core	Ferrite
Wire	Enameled copper
Base	LCP
Adhesive	Epoxy resin
Terminal	Sn
Rated Current	

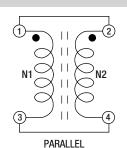
..... Inductance drops 30 % at Isat Temperature Rise40 °C at rated Irms Packaging...... 400 pcs. per 13-inch reel

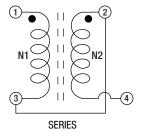
How to Order

SRF1260 - 100M Model Value Code (see table)

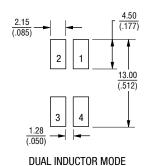
Electrical Schematic

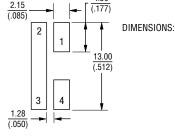






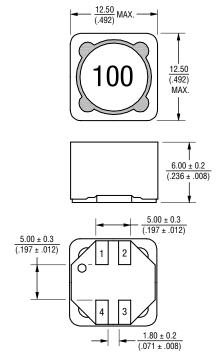
Recommended Layout





SERIES MODE

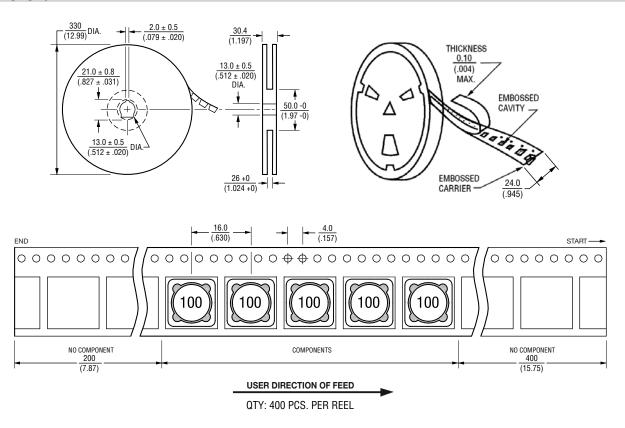
Product Dimensions



^{*}RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011. Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

Packaging Specifications



DIMENSIONS:

(INCHES)